

# OPA620

## Wideband Precision OPERATIONAL AMPLIFIER

### FEATURES

- LOW NOISE:  $2.3\text{nV}/\sqrt{\text{Hz}}$
- HIGH OUTPUT CURRENT: 100mA
- FAST SETTLING: 25ns (0.01%)
- GAIN-BANDWIDTH PRODUCT: 200MHz
- UNITY-GAIN STABLE
- LOW OFFSET VOLTAGE:  $\pm 200\mu\text{V}$
- LOW DIFFERENTIAL GAIN/PHASE ERROR
- 8-PIN DIP, SO-8 PACKAGES

### APPLICATIONS

- LOW NOISE PREAMPLIFIER
- LOW NOISE DIFFERENTIAL AMPLIFIER
- HIGH-RESOLUTION VIDEO
- HIGH-SPEED SIGNAL PROCESSING
- LINE DRIVER
- ADC/DAC BUFFER
- ULTRASOUND
- PULSE/RF AMPLIFIERS
- ACTIVE FILTERS

### DESCRIPTION

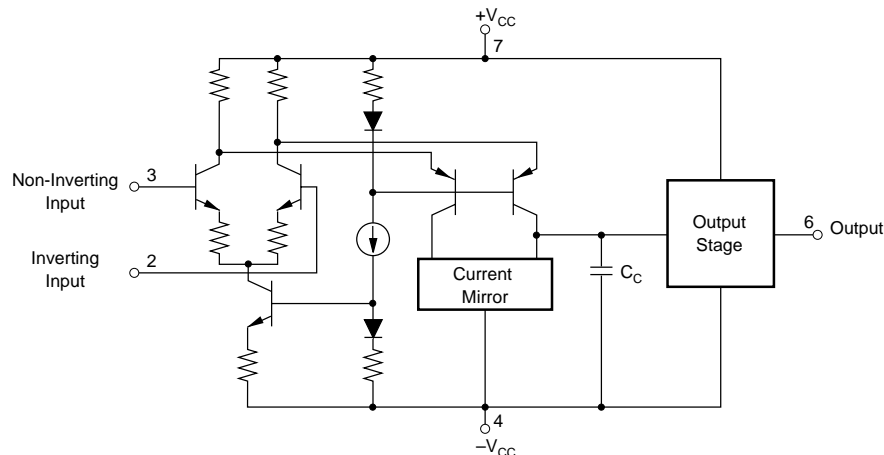
The OPA620 is a precision wideband monolithic operational amplifier featuring very fast settling time, low differential gain and phase error, and high output current drive capability.

The OPA620 is internally compensated for unity-gain stability. This amplifier has a very low offset, fully symmetrical differential input due to its "classical" operational amplifier circuit architecture. Unlike "current-feedback" amplifier designs, the OPA620 may be

used in all op amp applications requiring high speed and precision.

Low noise and distortion, wide bandwidth, and high linearity make this amplifier suitable for RF and video applications. Short-circuit protection is provided by an internal current-limiting circuit.

The OPA620 is available in plastic and ceramic DIP and SO-8 packages. Two temperature ranges are offered:  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  and  $-55^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ .



International Airport Industrial Park • Mailing Address: PO Box 11400, Tucson, AZ 85734 • Street Address: 6730 S. Tucson Blvd., Tucson, AZ 85706 • Tel: (520) 746-1111 • Twx: 910-952-1111  
Internet: <http://www.burr-brown.com/> • FAXLine: (800) 548-6133 (US/Canada Only) • Cable: BBRCORP • Telex: 066-6491 • FAX: (520) 889-1510 • Immediate Product Info: (800) 548-6132

# SPECIFICATIONS

## ELECTRICAL

At  $V_{CC} = \pm 5VDC$ ,  $R_L = 100\Omega$ , and  $T_A = +25^\circ C$ , unless otherwise noted.

PARAMETER	CONDITIONS	OPA620KP, KU			OPA620SG			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
<b>INPUT NOISE</b> Voltage: $f_o = 100Hz$ $f_o = 1kHz$ $f_o = 10kHz$ $f_o = 100kHz$ $f_o = 1MHz$ to $100MHz$ $f_B = 100Hz$ to $10MHz$ Current: $f_o = 10kHz$ to $100MHz$	$R_S = 0\Omega$		10			*		$nV/\sqrt{Hz}$
			5.5			*		$nV/\sqrt{Hz}$
			3.3			*		$nV/\sqrt{Hz}$
			2.5			*		$nV/\sqrt{Hz}$
			2.3			*		$nV/\sqrt{Hz}$
			8.0			*		$\mu V_{rms}$
			2.3			*		$pA/\sqrt{Hz}$
<b>OFFSET VOLTAGE<sup>(1)</sup></b> Input Offset Voltage Average Drift Supply Rejection	$V_{CM} = 0VDC$ $T_A = T_{MIN}$ to $T_{MAX}$ $\pm V_{CC} = 4.5V$ to $5.5V$		$\pm 200$	$\pm 1000$		*	*	$\mu V$
			$\pm 8$			*		$\mu V/^\circ C$
		50	60		*	*		dB
<b>BIAS CURRENT</b> Input Bias Current	$V_{CM} = 0VDC$		15	30		*	*	$\mu A$
<b>OFFSET CURRENT</b> Input Offset Current	$V_{CM} = 0VDC$		0.2	2		*	*	$\mu A$
<b>INPUT IMPEDANCE</b> Differential Common-Mode	Open-Loop		$15 \parallel 1$			*		$k\Omega \parallel pF$
			$1 \parallel 1$			*		$M\Omega \parallel pF$
<b>INPUT VOLTAGE RANGE</b> Common-Mode Input Range Common-Mode Rejection	$V_{IN} = \pm 2.5VDC$ , $V_O = 0VDC$	$\pm 3.0$	$\pm 3.5$		*	*		V
		65	75		*	*		dB
<b>OPEN-LOOP GAIN, DC</b> Open-Loop Voltage Gain	$R_L = 100\Omega$ $R_L = 50\Omega$	50	60		*	*		dB
		48	58		*	*		dB
<b>FREQUENCY RESPONSE</b> Closed-Loop Bandwidth (-3dB)  Gain-Bandwidth Product Differential Gain Differential Phase Harmonic Distortion <sup>(2)</sup>  Full Power Bandwidth <sup>(2)</sup>  Slew Rate <sup>(2)</sup> Overshoot Settling Time: 0.1% 0.01%  Phase Margin Rise Time	Gain = +1V/V Gain = +2V/V Gain = +5V/V Gain = +10V/V Gain $\geq$ +5V/V 3.58MHz, G = +1V/V 3.58MHz, G = +1V/V G = +2V/V, f = 10MHz, $V_O = 2Vp-p$ Second Harmonic Third Harmonic $V_O = 5Vp-p$ , Gain = +1V/V $V_O = 2Vp-p$ , Gain = +1V/V 2V Step, Gain = -1V/V 2V Step, Gain = -1V/V 2V Step, Gain = -1V/V Gain = +1V/V Gain = +1V/V, 10% to 90% $V_O = 100mVp-p$ ; Small Signal $V_O = 6Vp-p$ ; Large Signal		300			*		MHz
			100			*		MHz
			40			*		MHz
			20			*		MHz
			200			*		MHz
			0.05			*		%
			0.05			*		Degrees
			-61	-50		*	*	dBc <sup>(3)</sup>
			-65	-55		*	*	dBc
		11	16		*	*		MHz
		27	40		*	*		MHz
		175	250		*	*		V/ $\mu s$
			10		*	*		%
			13		*	*		ns
			25		*	*		ns
	60		*	*		Degrees		
	2		*	*		ns		
	22		*	*		ns		
<b>RATED OUTPUT</b> Voltage Output  Output Resistance Load Capacitance Stability Short Circuit Current	$R_L = 100\Omega$ $R_L = 50\Omega$ 1MHz, Gain = +1V/V Gain = +1V/V Continuous	$\pm 3.0$	$\pm 3.5$		*	*		V
		$\pm 2.5$	$\pm 3.0$		*	*		V
			0.015		*	*		$\Omega$
			20		*	*		pF
		$\pm 150$		*	*		mA	
<b>POWER SUPPLY</b> Rated Voltage Derated Performance Current, Quiescent	$\pm V_{CC}$ $\pm V_{CC}$ $I_O = 0mA$	4.0	5	6.0	*	*	*	VDC
			21	23		*	*	VDC
						*	*	*
<b>TEMPERATURE RANGE</b> Specification: KP, KU SG Operating: SG KP, KU  $\theta_{JA}$ : SG KP KU	Ambient Temperature	-40		+85	*		*	$^\circ C$
					-55		+125	$^\circ C$
	Ambient Temperature	-40		+85			+125	$^\circ C$
						125		$^\circ C/W$
			90					$^\circ C/W$
			100					$^\circ C/W$

The information provided herein is believed to be reliable; however, BURR-BROWN assumes no responsibility for inaccuracies or omissions. BURR-BROWN assumes no responsibility for the use of this information, and all use of such information shall be entirely at the user's own risk. Prices and specifications are subject to change without notice. No patent rights or licenses to any of the circuits described herein are implied or granted to any third party. BURR-BROWN does not authorize or warrant any BURR-BROWN product for use in life support devices and/or systems.



OPA620

# SPECIFICATIONS (CONT)

## ELECTRICAL (FULL TEMPERATURE RANGE SPECIFICATIONS)

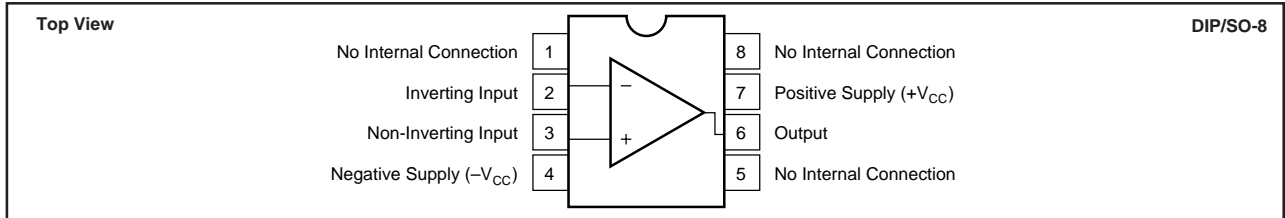
At  $V_{CC} = \pm 5VDC$ ,  $R_L = 100\Omega$ , and  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.

PARAMETER	CONDITIONS	OPA620KP, KU			OPA620SG			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
<b>TEMPERATURE RANGE</b> Specification: KP, KU SG	Ambient Temperature	-40		+85	*		*	°C °C
<b>OFFSET VOLTAGE<sup>(1)</sup></b> Average Drift Supply Rejection	Full Temp. 0°C to +70°C $\pm V_{CC} = 4.5V$ to $5.5V$ Full Temp., $\pm V_{CC} = 4.5$ to $5.5V$	45 40	$\pm 8$ 60 55		*	*	*	$\mu V/^\circ C$ dB dB
<b>BIAS CURRENT</b> Input Bias Current	Full Temp., $V_{CM} = 0VDC$		15 40			*	*	$\mu A$
<b>OFFSET CURRENT</b> Input Offset Current	Full Temp., $V_{CM} = 0VDC$		0.2 5			*	*	$\mu A$
<b>INPUT VOLTAGE RANGE</b> Common-Mode Input Range Common-Mode Rejection	$V_{IN} = \pm 2.5VDC$ , $V_O = 0VDC$	$\pm 2.5$ 60	$\pm 3.0$ 75		*	*	*	V dB
<b>OPEN LOOP GAIN, DC</b> Open-Loop Voltage Gain	$R_L = 100\Omega$ $R_L = 50\Omega$	46 44	60 58		*	*	*	dB dB
<b>RATED OUTPUT</b> Voltage Output	0°C to +70°C, $R_L = 100\Omega$ -40°C to +85°C, $R_L = 100\Omega$ 0°C to +70°C, $R_L = 50\Omega$ -40°C to +85°C, $R_L = 50\Omega$	$\pm 3.0$ $\pm 2.75$ $\pm 2.5$ $\pm 2.25$	$\pm 3.5$ $\pm 3.25$ $\pm 3.0$ $\pm 2.7$		*	*	*	V V V V
<b>POWER SUPPLY</b> Current, Quiescent	$I_O = 0mA$		21 25			*	*	mA

\* Same specifications as for KP, KU.

NOTES: (1) Offset Voltage specifications are also guaranteed with units fully warmed up. (2) Parameter is guaranteed by characterization. (3) dBc = dB referred to carrier-input signal.

## PIN CONFIGURATION



## ORDERING INFORMATION

Basic Model Number	OPA620	( )	( )
Performance Grade Code			
K = -40°C to +85°C			
S = -55°C to +125°C			
Package Code			
G = 8-pin Ceramic DIP			
P = 8-pin Plastic DIP			
U = SO-8 Surface Mount			

## PACKAGE INFORMATION

PRODUCT	PACKAGE	PACKAGE DRAWING NUMBER <sup>(1)</sup>
OPA620KP	8-Pin Plastic DIP	006
OPA620KU	SO-8 Surface Mount	182
OPA620SG	8-Pin Ceramic DIP	157

NOTE: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix C of Burr-Brown IC Data Book.

## ABSOLUTE MAXIMUM RATINGS

Supply	$\pm 7VDC$
Internal Power Dissipation <sup>(1)</sup>	See Applications Information
Differential Input Voltage	Total $V_{CC}$
Input Voltage Range	See Applications Information
Storage Temperature Range: SG	-65°C to +150°C
KP, KU	-40°C to +125°C
Lead Temperature (soldering, 10s)	+300°C
(soldering, SO-8, 3s)	+260°C
Output Short Circuit to Ground (+25°C)	Continuous to Ground
Junction Temperature ( $T_J$ )	+175°C

NOTE: (1) Packages must be derated based on specified  $\theta_{JA}$ . Maximum  $T_J$  must be observed.



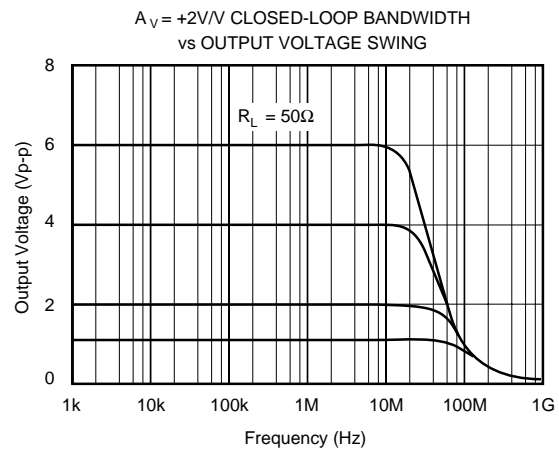
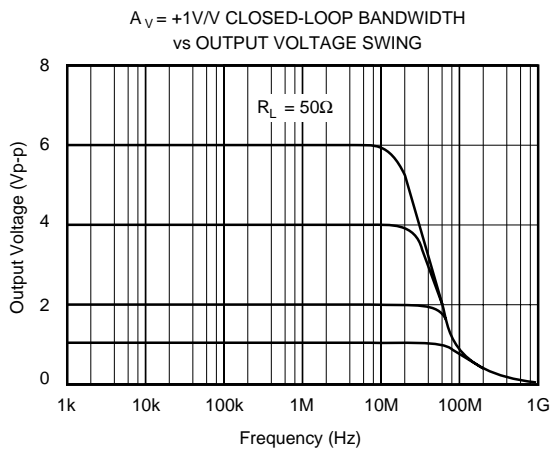
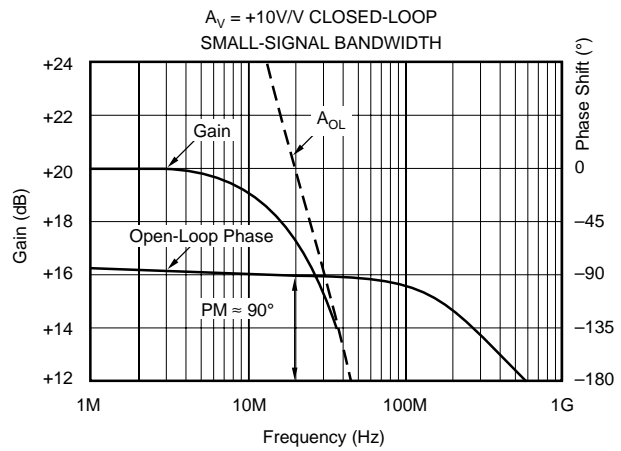
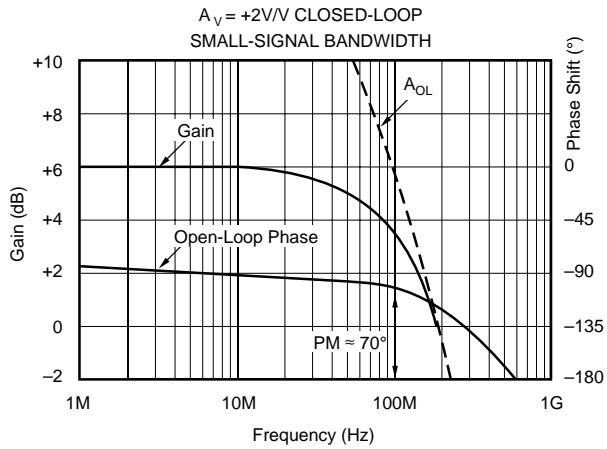
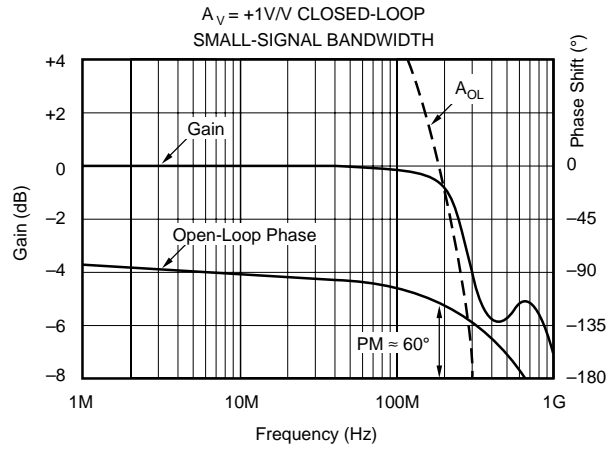
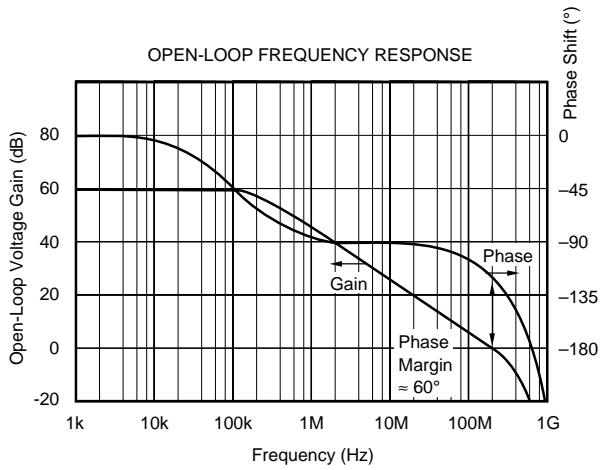
## ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

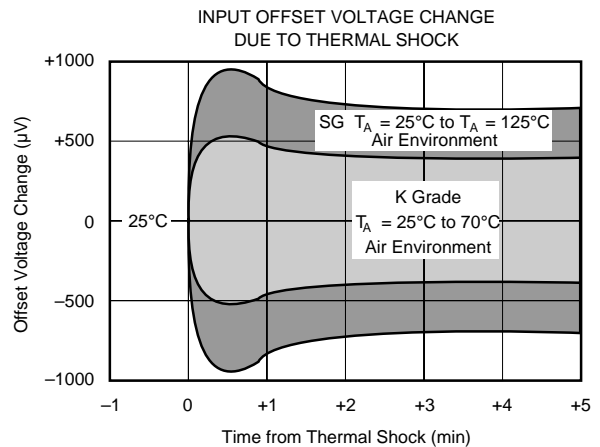
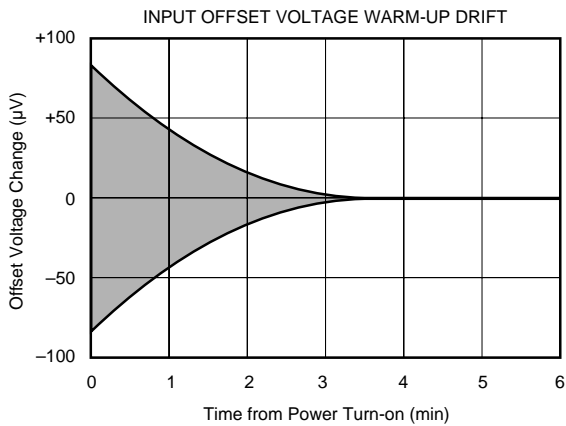
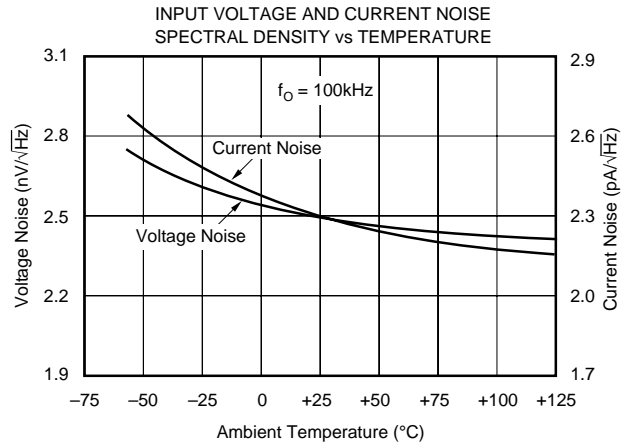
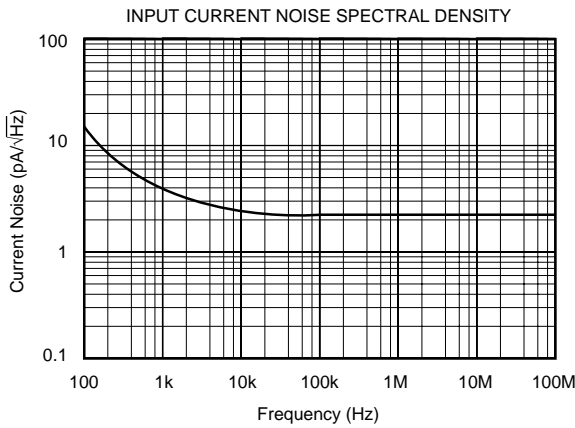
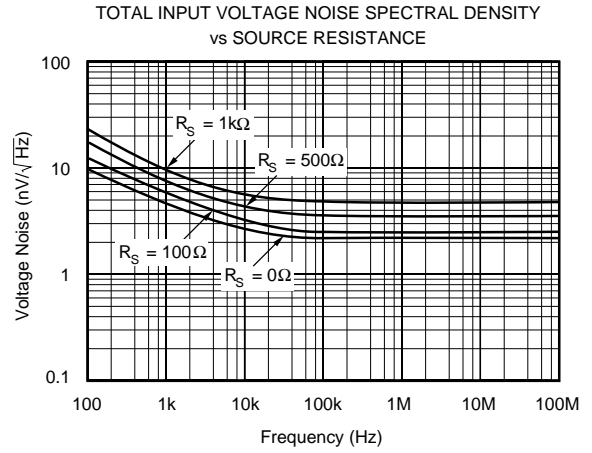
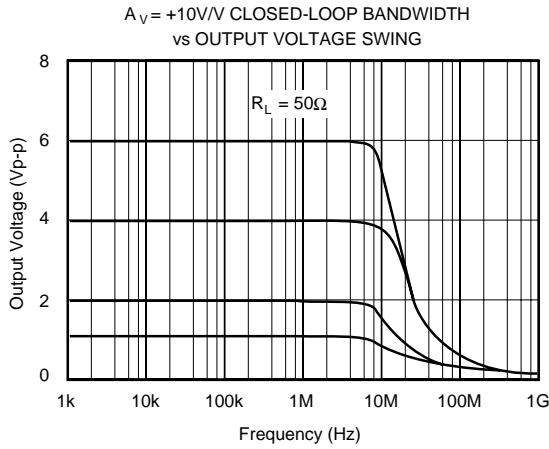
# TYPICAL PERFORMANCE CURVES (CONT)

At  $V_{CC} = \pm 5VDC$ ,  $R_L = 100\Omega$ , and  $T_A = +25^\circ C$ , unless otherwise noted.



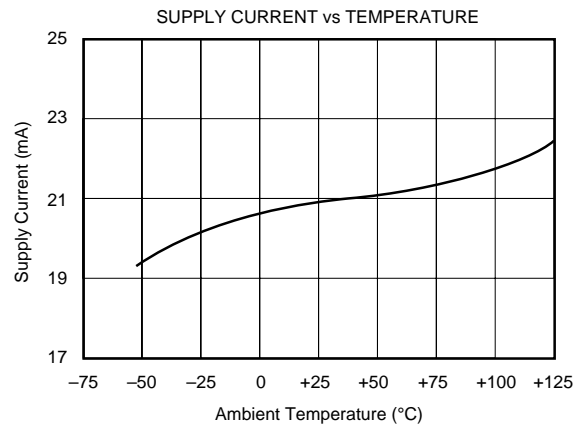
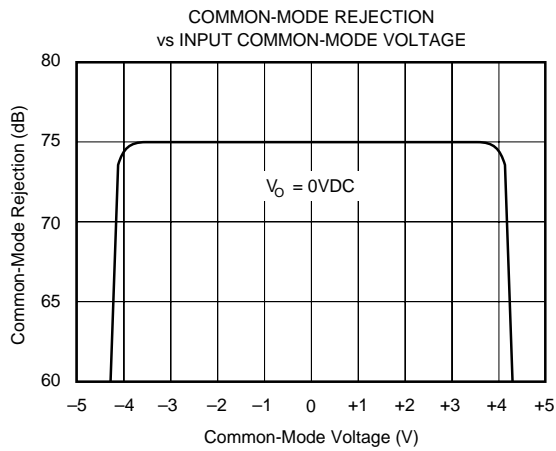
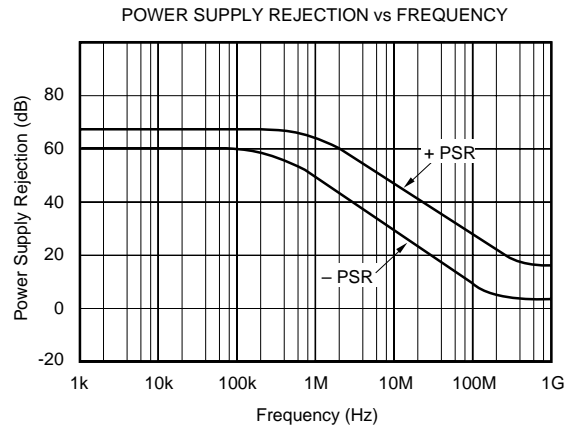
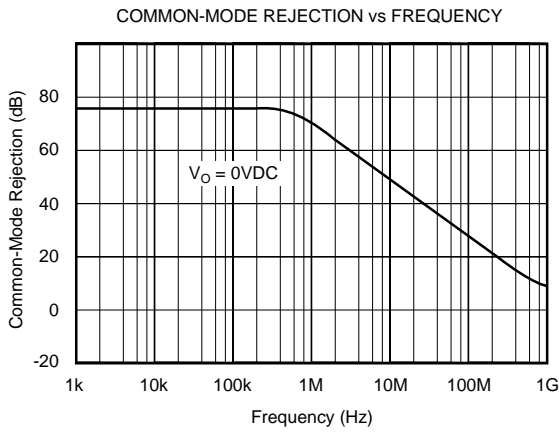
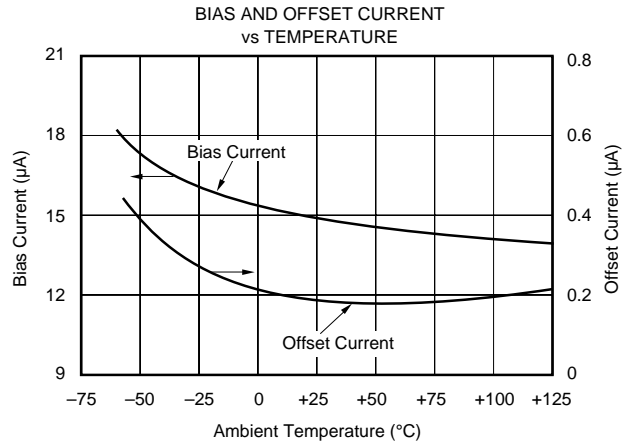
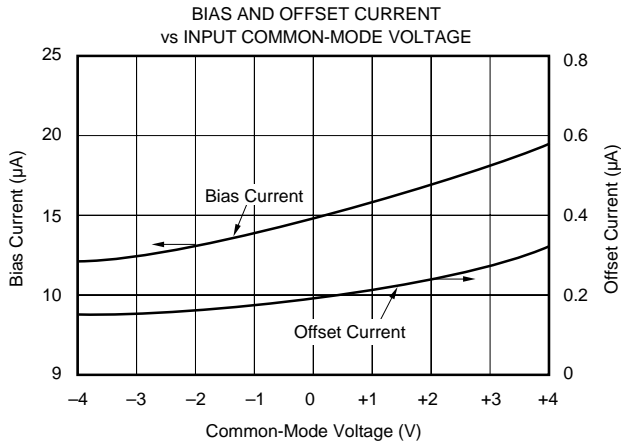
# TYPICAL PERFORMANCE CURVES (CONT)

At  $V_{CC} = \pm 5VDC$ ,  $R_L = 100\Omega$ , and  $T_A = +25^\circ C$ , unless otherwise noted.



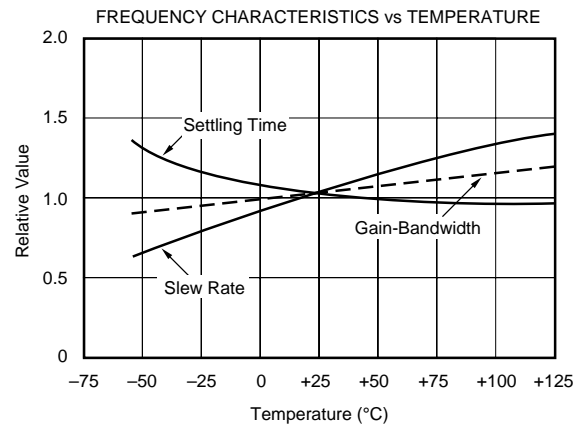
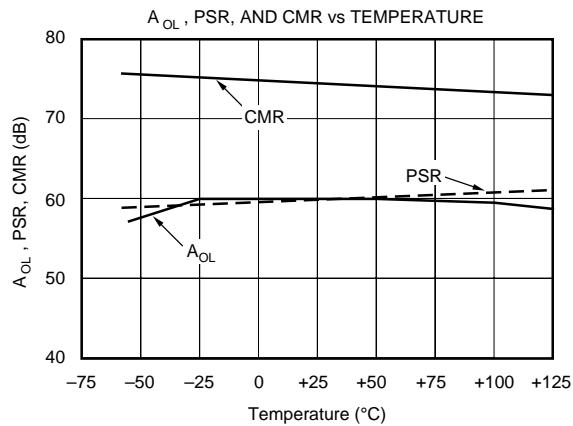
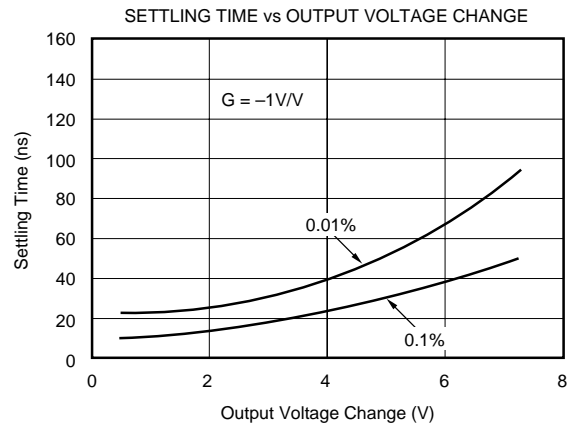
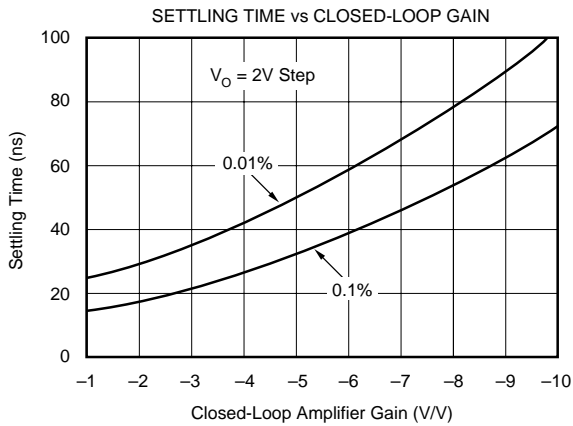
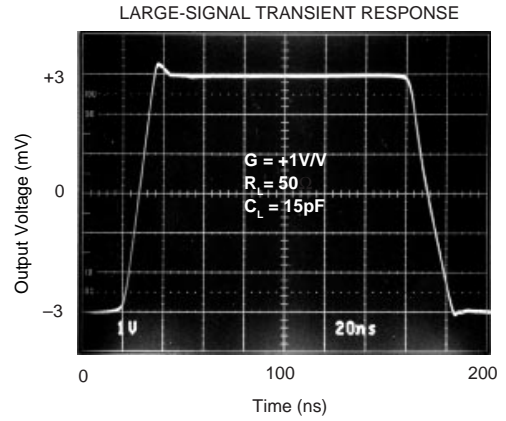
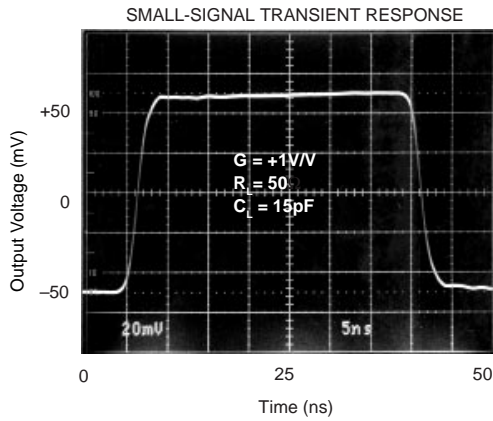
# TYPICAL PERFORMANCE CURVES (CONT)

At  $V_{CC} = \pm 5VDC$ ,  $R_L = 100\Omega$ , and  $T_A = +25^\circ C$ , unless otherwise noted.



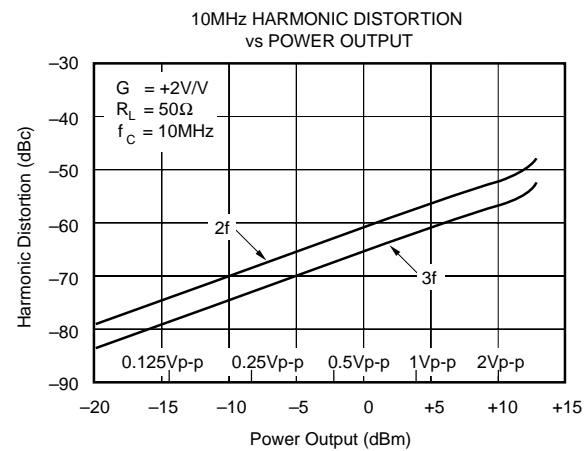
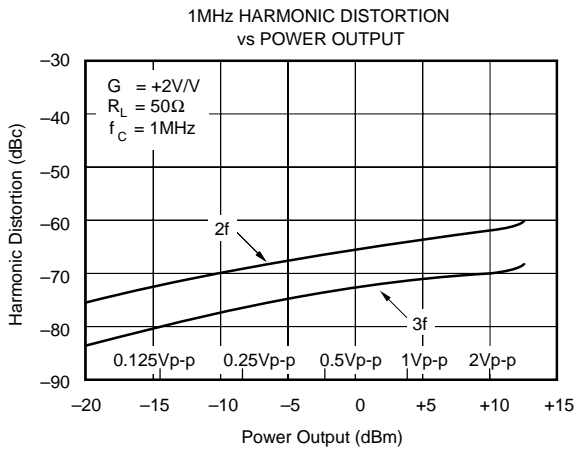
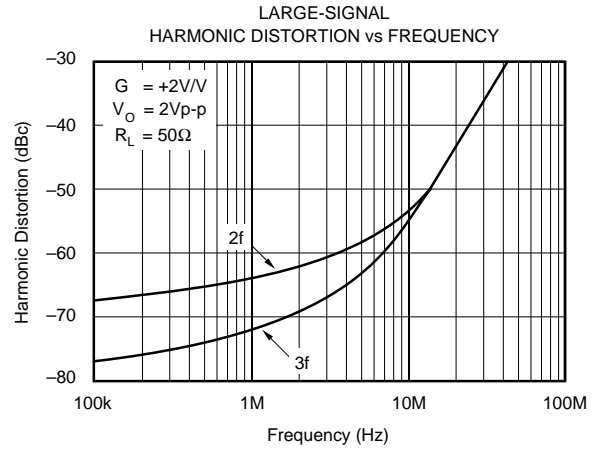
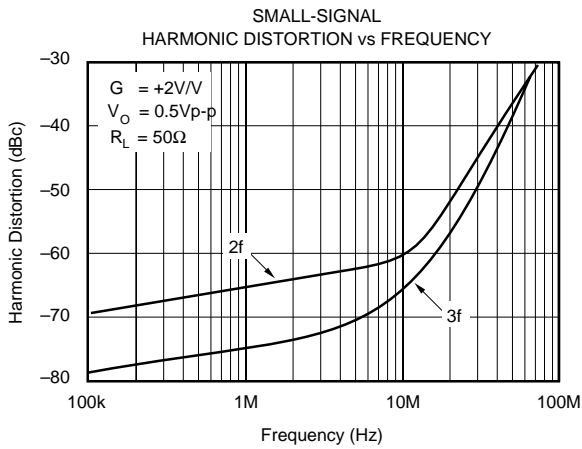
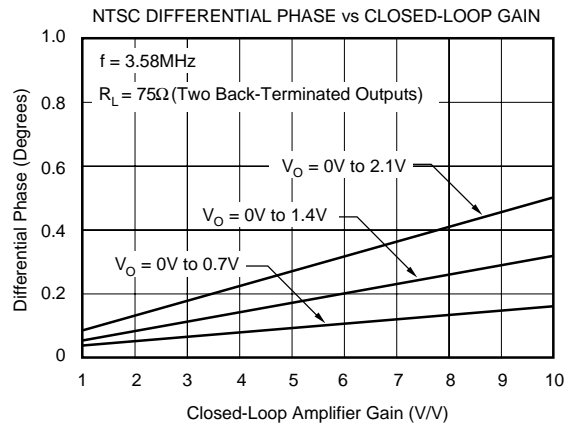
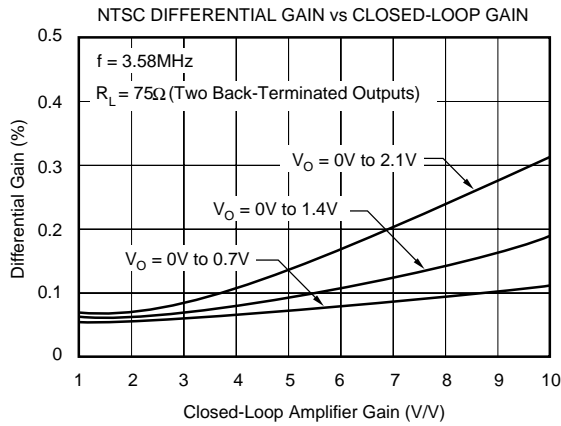
# TYPICAL PERFORMANCE CURVES (CONT)

At  $V_{CC} = \pm 5VDC$ ,  $R_L = 100\Omega$ , and  $T_A = +25^\circ C$ , unless otherwise noted.



# TYPICAL PERFORMANCE CURVES (CONT)

At  $V_{CC} = \pm 5VDC$ ,  $R_L = 100\Omega$ , and  $T_A = +25^\circ C$ , unless otherwise noted.



# APPLICATIONS INFORMATION

## DISCUSSION OF PERFORMANCE

The OPA620 provides a level of speed and precision not previously attainable in monolithic form. Unlike current feedback amplifiers, the OPA620's design uses a "classical" operational amplifier architecture and can therefore be used in all traditional operational amplifier applications. While it is true that current feedback amplifiers can provide wider bandwidth at higher gains, they offer many disadvantages. The asymmetrical input characteristics of current feedback amplifiers (i.e., one input is a low impedance) prevents them from being used in a variety of applications. In addition, unbalanced inputs make input bias current errors difficult to correct. Bias current cancellation through matching of inverting and non-inverting input resistors is impossible because the input bias currents are uncorrelated. Current noise is also asymmetrical and is usually significantly higher on the inverting input. Perhaps most important, settling time to 0.01% is often extremely poor due to internal design tradeoffs. Many current feedback designs exhibit settling times to 0.01% in excess of 10 *microseconds* even though 0.1% settling times are reasonable. Such amplifiers are completely inadequate for fast settling 12-bit applications.

The OPA620's "classical" operational amplifier architecture employs true differential and fully symmetrical inputs to eliminate these troublesome problems. All traditional circuit configurations and op amp theory apply to the OPA620. The use of low-drift thin-film resistors allows internal operating currents to be laser-trimmed at wafer-level to optimize AC performance such as bandwidth and settling time, as well as DC parameters such as input offset voltage and drift. The result is a wideband, high-frequency monolithic operational amplifier with a gain-bandwidth product of 200MHz, a 0.01% settling time of 25ns, and an input offset voltage of 200 $\mu$ V.

## WIRING PRECAUTIONS

Maximizing the OPA620's capability requires some wiring precautions and high-frequency layout techniques. Oscillation, ringing, poor bandwidth and settling, gain peaking, and instability are typical problems plaguing all high-speed amplifiers when they are improperly used. In general, all printed circuit board conductors should be wide to provide low resistance, low impedance signal paths. They should also be as short as possible. The entire physical circuit should be as small as practical. Stray capacitances should be minimized, especially at high impedance nodes, such as the amplifier's input terminals. Stray signal coupling from the output or power supplies to the inputs should be minimized. All circuit element leads should be no longer than 1/4 inch (6mm) to minimize lead inductance, and low values of resistance should be used. This will minimize time constants formed with the circuit capacitances and will eliminate stray, parasitic circuits.

Grounding is the most important application consideration for the OPA620, as it is with all high-frequency circuits.

Oscillations at frequencies of 200MHz and above can easily occur if good grounding techniques are not used. A heavy ground plane (2 oz. copper recommended) should connect all unused areas on the component side. Good ground planes can reduce stray signal pickup, provide a low resistance, low inductance common return path for signal and power, and can conduct heat from active circuit package pins into ambient air by convection.

Supply bypassing is extremely critical and must *always* be used, especially when driving high current loads. Both power supply leads should be bypassed to ground as close as possible to the amplifier pins. Tantalum capacitors (1 $\mu$ F to 10 $\mu$ F) with very short leads are recommended. A parallel 0.1 $\mu$ F ceramic should be added at the supply pins. Surface mount bypass capacitors will produce excellent results due to their low lead inductance. Additionally, suppression filters can be used to isolate noisy supply lines. Properly bypassed and modulation-free power supply lines allow full amplifier output and optimum settling time performance.

## Points to Remember

1) Don't use point-to-point wiring as the increase in wiring inductance will be detrimental to AC performance. However, if it must be used, very short, direct signal paths are required. The input signal ground return, the load ground return, and the power supply common should all be connected to the same physical point to eliminate ground loops, which can cause unwanted feedback.

2) Good component selection is essential. Capacitors used in critical locations should be a low inductance type with a high quality dielectric material. Likewise, diodes used in critical locations should be Schottky barrier types, such as HP5082-2835 for fast recovery and minimum charge storage. Ordinary diodes will not be suitable in RF circuits.

3) Whenever possible, solder the OPA620 directly into the PC board without using a socket. Sockets add parasitic capacitance and inductance, which can seriously degrade AC performance or produce oscillations. If sockets must be used, consider using zero-profile solderless sockets such as Augat part number 8134-HC-5P2. Alternately, Teflon<sup>®</sup> stand-offs located close to the amplifier's pins can be used to mount feedback components.

4) Resistors used in feedback networks should have values of a few hundred ohms for best performance. Shunt capacitance problems limit the acceptable resistance range to about 1k $\Omega$  on the high end and to a value that is within the amplifier's output drive limits on the low end. Metal film and carbon resistors will be satisfactory, but wirewound resistors (even "non-inductive" types) are absolutely *unacceptable* in high-frequency circuits.

5) Surface-mount components (chip resistors, capacitors, etc) have low lead inductance and are therefore strongly recommended. Circuits using all surface-mount components with the OPA620KU (SO-8 package) will offer the best AC performance. The parasitic package inductance and capacitance for the SO-8 is lower than the both the Cerdip and 8-lead Plastic DIP.

Teflon<sup>®</sup> E. I. Du Pont de Nemours & Co.

- 6) Avoid overloading the output. Remember that output current must be provided by the amplifier to drive its own feedback network as well as to drive its load. Lowest distortion is achieved with high impedance loads.
- 7) Don't forget that these amplifiers use  $\pm 5V$  supplies. Although they will operate perfectly well with  $+5V$  and  $-5.2V$ , use of  $\pm 15V$  supplies will destroy the part.
- 8) Standard commercial test equipment has not been designed to test devices in the OPA620's speed range. Benchtop op amp testers and ATE systems will require a special test head to successfully test these amplifiers.
- 9) Terminate transmission line loads. Unterminated lines, such as coaxial cable, can appear to the amplifier to be a capacitive or inductive load. By terminating a transmission line with its characteristic impedance, the amplifier's load then appears purely resistive.
- 10) Plug-in prototype boards and wire-wrap boards will not be satisfactory. A clean layout using RF techniques is essential; there are no shortcuts.

### OFFSET VOLTAGE ADJUSTMENT

The OPA620's input offset voltage is laser-trimmed and will require no further adjustment for most applications. However, if additional adjustment is needed, the circuit in Figure 1 can be used without degrading offset drift with temperature. Avoid external adjustment whenever possible since extraneous noise, such as power supply noise, can be inadvertently coupled into the amplifier's inverting input terminal. Remember that additional offset errors can be created by the amplifier's input bias currents. Whenever possible, match the impedance seen by both inputs as is shown with  $R_3$ . This will reduce input bias current errors to the amplifier's offset current, which is typically only  $0.2\mu A$ .

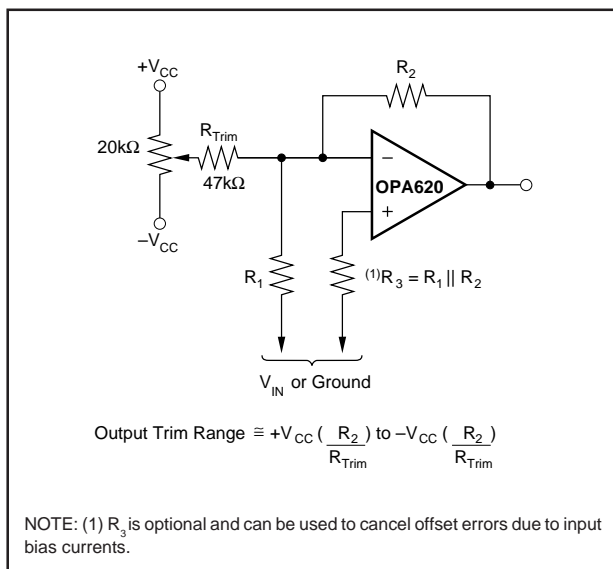


FIGURE 1. Offset Voltage Trim.

### INPUT PROTECTION

Static damage has been well recognized for MOSFET devices, but any semiconductor device deserves protection from this potentially damaging source. The OPA620 incorporates on-chip ESD protection diodes as shown in Figure 2. This eliminates the need for the user to add external protection diodes, which can add capacitance and degrade AC performance.

All pins on the OPA620 are internally protected from ESD by means of a pair of back-to-back reverse-biased diodes to either power supply as shown. These diodes will begin to conduct when the input voltage exceeds either power supply by about  $0.7V$ . This situation can occur with loss of the amplifier's power supplies while a signal source is still present. The diodes can typically withstand a continuous current of  $30mA$  without destruction. To insure long term reliability, however, diode current should be externally limited to  $10mA$  or so whenever possible.

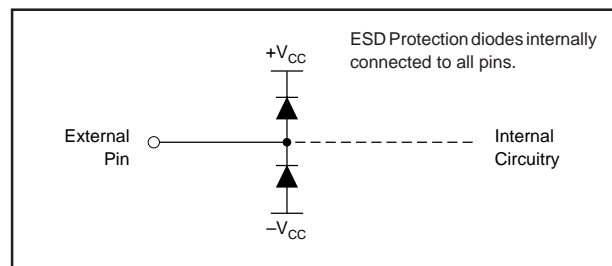


FIGURE 2. Internal ESD Protection.

The internal protection diodes are designed to withstand  $2.5kV$  (using Human Body Model) and will provide adequate ESD protection for most normal handling procedures. However, static damage can cause subtle changes in amplifier input characteristics without necessarily destroying the device. In precision operational amplifiers, this may cause a noticeable degradation of offset voltage and drift. Therefore, static protection is strongly recommended when handling the OPA620.

### OUTPUT DRIVE CAPABILITY

The OPA620's design uses large output devices and has been optimized to drive  $50\Omega$  and  $75\Omega$  resistive loads. The device can easily drive  $6Vp-p$  into a  $50\Omega$  load. This high-output drive capability makes the OPA620 an ideal choice for a wide range of RF, IF, and video applications. In many cases, additional buffer amplifiers are unneeded.

Internal current-limiting circuitry limits output current to about  $150mA$  at  $25^\circ C$ . This prevents destruction from accidental shorts to common and eliminates the need for external current-limiting circuitry. Although the device can withstand momentary shorts to either power supply, it is not recommended.

Many demanding high-speed applications such as ADC/DAC buffers require op amps with low wideband output impedance. For example, low output impedance is essential when driving the signal-dependent capacitances at the inputs of flash A/D converters. As shown in Figure 3, the OPA620 maintains very low closed-loop output impedance over frequency. Closed-loop output impedance increases with frequency since loop gain is decreasing with frequency.

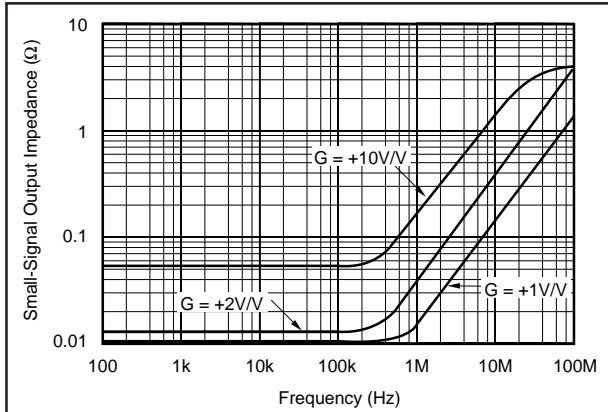


FIGURE 3. Small-Signal Output Impedance vs Frequency.

### THERMAL CONSIDERATIONS

The OPA620 does not require a heat sink for operation in most environments. The use of a heat sink, however, will reduce the internal thermal rise and will result in cooler, more reliable operation. At extreme temperatures and under full load conditions a heat sink is necessary. See “Maximum Power Dissipation” curve, Figure 4.

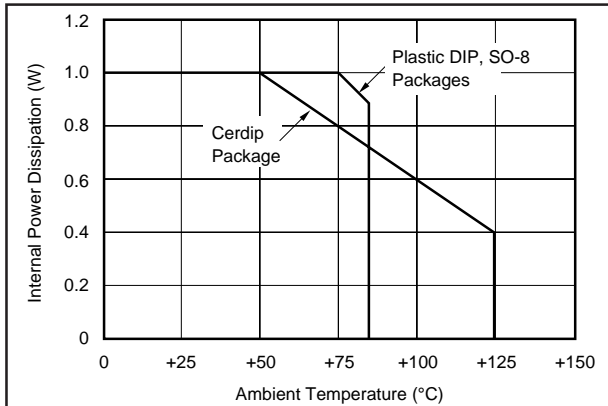


FIGURE 4. Maximum Power Dissipation.

The internal power dissipation is given by the equation  $P_D = P_{DQ} + P_{DL}$ , where  $P_{DQ}$  is the quiescent power dissipation and  $P_{DL}$  is the power dissipation in the output stage due to the load. (For  $\pm V_{CC} = \pm 5V$ ,  $P_{DQ} = 10V \times 23mA = 230mW$ , max). For the case where the amplifier is driving a grounded load ( $R_L$ ) with a DC voltage ( $\pm V_{OUT}$ ) the maximum value of  $P_{DL}$  occurs at  $\pm V_{OUT} = \pm V_{CC}/2$ , and is equal to  $P_{DL, max} = (\pm V_{CC})^2/4R_L$ . Note that it is the voltage across the output transistor, and not the load, that determines the power dissipated in the output stage.

When the output is shorted to ground,  $P_{DL} = 5V \times 150mA = 750mW$ . Thus,  $P_D = 230mW + 750mW \approx 1W$ . Note that the short-circuit condition represents the maximum amount of internal power dissipation that can be generated. Thus, the “Maximum Power Dissipation” curve starts at 1W and is derated based on a 175°C maximum junction temperature and the junction-to-ambient thermal resistance,  $\theta_{JA}$ , of each package. The variation of short-circuit current with temperature is shown in Figure 5.

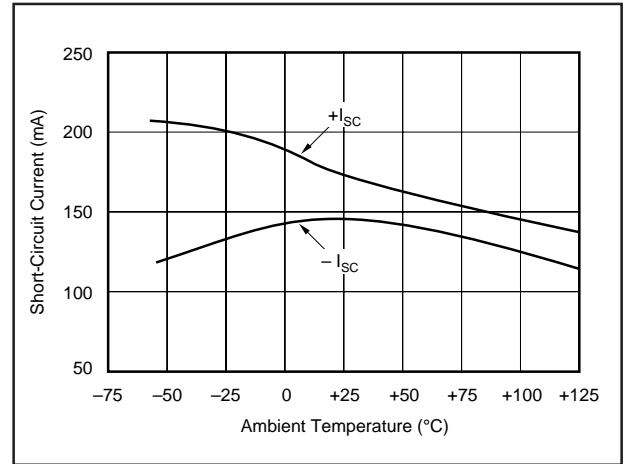


FIGURE 5. Short-Circuit Current vs Temperature.

### CAPACITIVE LOADS

The OPA620’s output stage has been optimized to drive resistive loads as low as 50Ω. Capacitive loads, however, will decrease the amplifier’s phase margin which may cause high frequency peaking or oscillations. Capacitive loads greater than 20pF should be buffered by connecting a small resistance, usually 5Ω to 25Ω, in series with the output as shown in Figure 6. This is particularly important when driving high capacitance loads such as flash A/D converters.

In general, capacitive loads should be minimized for optimum high frequency performance. Coax lines can be driven if the cable is properly terminated. The capacitance of coax cable (29pF/foot for RG-58) will not load the amplifier when the coaxial cable or transmission line is terminated in its characteristic impedance.

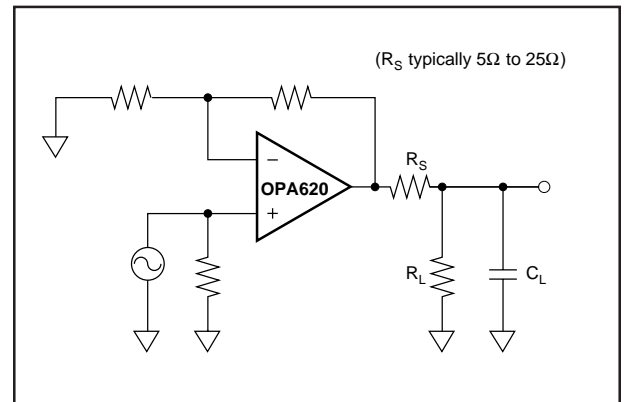


FIGURE 6. Driving Capacitive Loads.

## COMPENSATION

The OPA620 is internally compensated and is stable in unity gain with a phase margin of approximately  $60^\circ$ . However, the unity gain buffer is the most demanding circuit configuration for loop stability and oscillations are most likely to occur in this gain. If possible, use the device in a noise gain of two or greater to improve phase margin and reduce the susceptibility to oscillation. (Note that, from a stability standpoint, an inverting gain of  $-1V/V$  is equivalent to a noise gain of 2.) Gain and phase response for other gains are shown in the Typical Performance Curves.

The high-frequency response of the OPA620 in a good layout is very flat with frequency. However, some circuit configurations such as those where large feedback resistances are used, can produce high-frequency gain peaking. This peaking can be minimized by connecting a small capacitor in parallel with the feedback resistor. This capacitor compensates for the closed-loop, high frequency, transfer function zero that results from the time constant formed by the input capacitance of the amplifier (typically 2pF after PC board mounting), and the input and feedback resistors. The selected compensation capacitor may be a trimmer, a fixed capacitor, or a planned PC board capacitance. The capacitance value is strongly dependent on circuit layout and closed-loop gain. Using small resistor values will preserve the phase margin and avoid peaking by keeping the break frequency of this zero sufficiently high. When high closed-loop gains are required, a three-resistor attenuator (tee network) is recommended to avoid using large value resistors with large time constants.

## SETTLING TIME

Settling time is defined as the total time required, from the input signal step, for the output to settle to within the specified error band around the final value. This error band is expressed as a percentage of the value of the output transition, a 2V step. Thus, settling time to 0.01% requires an error band of  $\pm 200\mu V$  centered around the final value of 2V.

Settling time, specified in an inverting gain of one, occurs in only 25ns to 0.01% for a 2V step, making the OPA620 one of the fastest settling monolithic amplifiers commercially available. Settling time increases with closed-loop gain and output voltage change as described in the Typical Performance Curves. Preserving settling time requires critical attention to the details as mentioned under "Wiring Precautions." The amplifier also recovers quickly from input overloads. Overload recovery time to linear operation from a 50% overload is typically only 30ns.

In practice, settling time measurements on the OPA620 prove to be very difficult to perform. Accurate measurement is next to impossible in all but the very best equipped labs. Among other things, a fast flat-top generator and high speed oscilloscope are needed. Unfortunately, fast flat-top genera-

tors, which settle to 0.01% in sufficient time, are scarce and expensive. Fast oscilloscopes, however, are more commonly available. For best results, a sampling oscilloscope is recommended. Sampling scopes typically have bandwidths that are greater than 1GHz and very low capacitance inputs. They also exhibit faster settling times in response to signals that would tend to overload a real-time oscilloscope.

Figure 7 shows the test circuit used to measure settling time for the OPA620. This approach uses a 16-bit sampling oscilloscope to monitor the input and output pulses. These waveforms are captured by the sampling scope, averaged, and then subtracted from each other in software to produce the error signal. This technique eliminates the need for the traditional "false-summing junction," which adds extra parasitic capacitance. Note that instead of an additional flat-top generator, this technique uses the scope's built-in calibration source as the input signal.

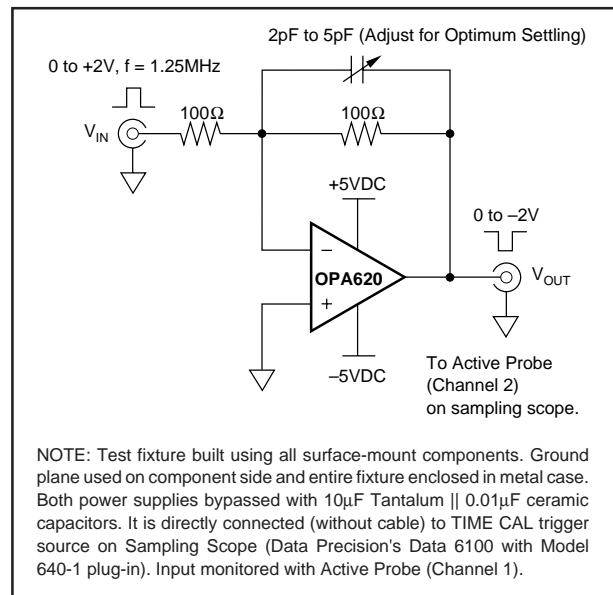


FIGURE 7. Settling Time Test Circuit.

## DIFFERENTIAL GAIN AND PHASE

Differential Gain (DG) and Differential Phase (DP) are among the more important specifications for video applications. DG is defined as the percent change in closed-loop gain over a specified change in output voltage level. DP is defined as the change in degrees of the closed-loop phase over the same output voltage change. Both DG and DP are specified at the NTSC sub-carrier frequency of 3.58MHz. DG and DP increase with closed-loop gain and output voltage transition as shown in the Typical Performance Curves. All measurements were performed using a Tektronix model VM700 Video Measurement Set.

## DISTORTION

The OPA620's harmonic distortion characteristics into a 50Ω load are shown vs frequency and power output in the Typical Performance Curves. Distortion can be further improved by increasing the load resistance as illustrated in Figure 8. Remember to include the contribution of the feedback resistance when calculating the effective load resistance seen by the amplifier.

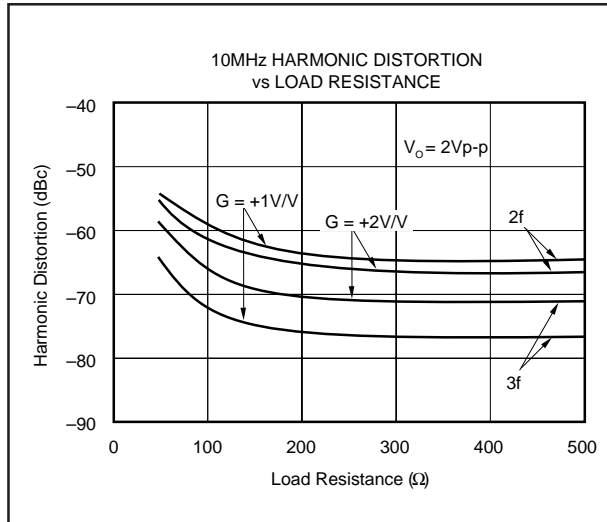


FIGURE 8. 10MHz Harmonic Distortion vs Load Resistance.

Two-tone third-order intermodulation distortion (IM) is an important parameter for many RF amplifier applications. Figure 9 shows the OPA620's two-tone third-order IM intercept vs frequency. For these measurements, tones were spaced 1MHz apart. This curve is particularly useful for determining the magnitude of the third-order IM products as a function of frequency, load resistance, and gain. For example, assume that the application requires the OPA620 to operate in a gain of +2V/V and drive 2Vp-p (4dBm for each tone) into 50Ω at a frequency of 10MHz. Referring to Figure 9 we find that the intercept point is +40dBm. The magnitude of the third-order IM products can now be easily calculated from the expression:

$$\text{Third IMD} = 2(\text{OPI}^3\text{P} - P_o)$$

- where  $\text{OPI}^3\text{P}$  = third-order output intercept, dBm
- $P_o$  = output level/tone, dBm/tone
- Third IMD = third-order intermodulation ratio below each output tone, dB

For this case  $\text{OPI}^3\text{P} = 40\text{dBm}$ ,  $P_o = 4\text{dBm}$ , and the third-order  $\text{IMD} = 2(40 - 10) = 72\text{dB}$  below either 4dBm tone. The OPA620's low IMD makes the device an excellent choice for a variety of RF signal processing applications.

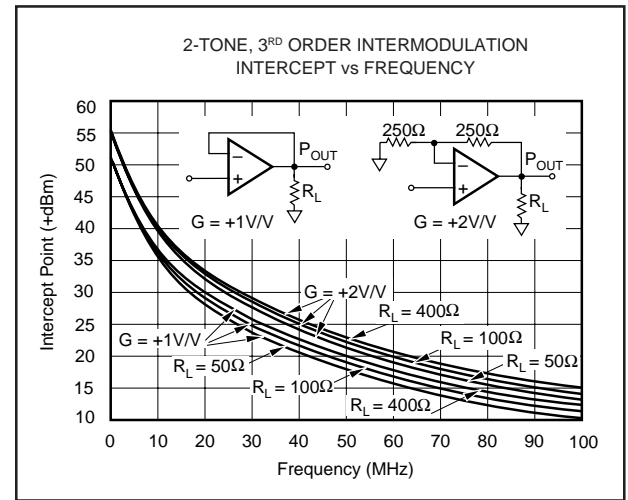


FIGURE 9. 2-Tone, 3rd Order Intermodulation Intercept vs Frequency.

## NOISE FIGURE

The OPA620's voltage and current noise spectral densities are specified in the Typical Performance Curves. For RF applications, however, Noise Figure (NF) is often the preferred noise specification since it allows system noise performance to be more easily calculated. The OPA620's Noise Figure vs Source Resistance is shown in Figure 10.

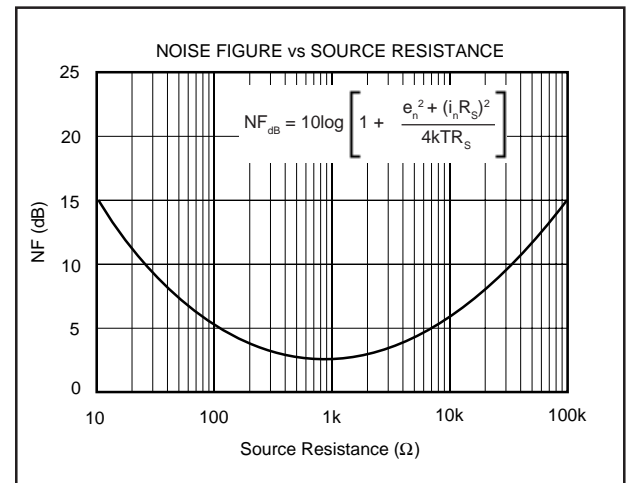


FIGURE 10. Noise Figure vs Source Resistance.

## SPICE MODELS

Computer simulation using SPICE is often useful when analyzing the performance of analog circuits and systems. This is particularly true for Video and RF amplifier circuits where parasitic capacitance and inductance can have a major effect on circuit performance. A SPICE model using MicroSim Corporation's PSpice is available for the OPA620. This simulation model is available through the Burr-Brown web site at [www.burr-brown.com](http://www.burr-brown.com) or by contacting the Burr-Brown Applications Department.

## RELIABILITY DATA

Extensive reliability testing has been performed on the OPA620. Accelerated life testing (2000 hours) at maximum

operating temperature was used to calculate MTTF at an ambient temperature of 25°C. These test results yield MTTF of: Cerdip package = 1.31E+9 Hours, Plastic DIP = 5.02E+7 Hours, and SO-8 = 2.94E+7 Hours. Additional tests such as PCT have also been performed. Reliability reports are available upon request for each of the package options offered.

## DEMONSTRATION BOARDS

Demonstration boards are available to speed prototyping. The 8-pin DIP packaged parts may be evaluated using the DEM-OPA65XP board while the SO-8 packaged part may be evaluated using the DEM-OPA65XU board. Both of these boards come partially assembled from your local distributor (the external resistors and the amplifier are not included).

## APPLICATIONS

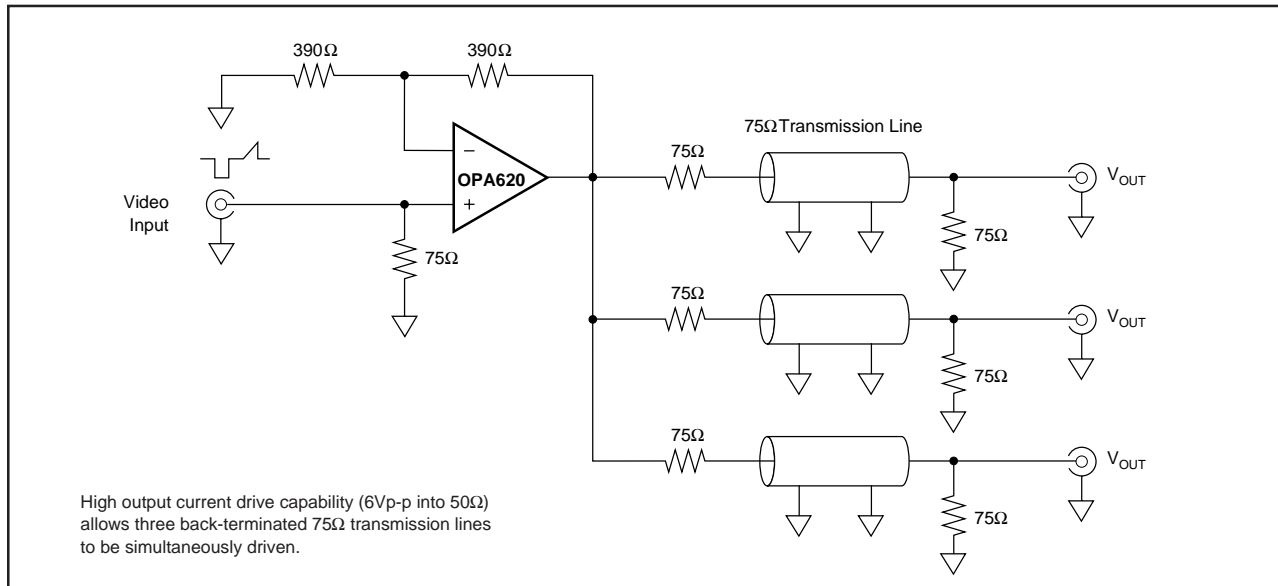


FIGURE 11. Video Distribution Amplifier.

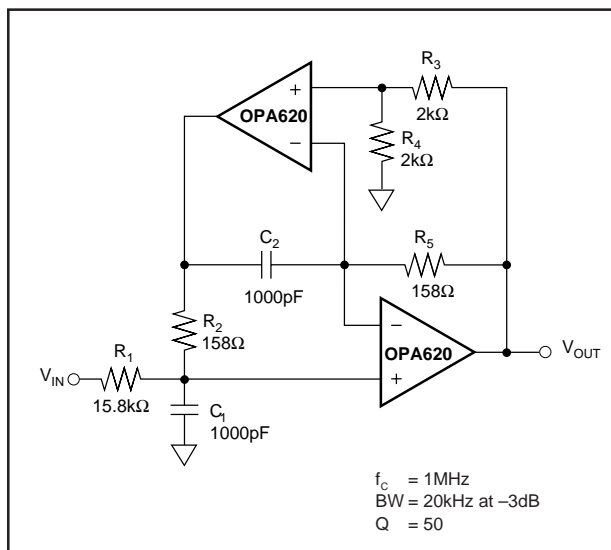


FIGURE 12. High-Q 1MHz Bandpass Filter.

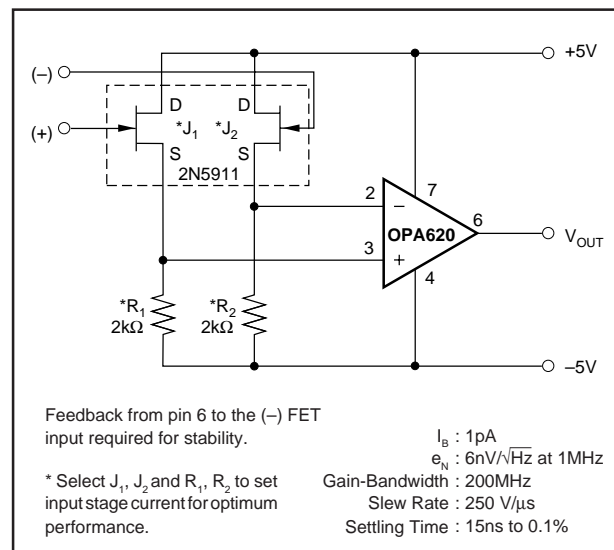


FIGURE 13. Low Noise, Wideband FET Input Op Amp.

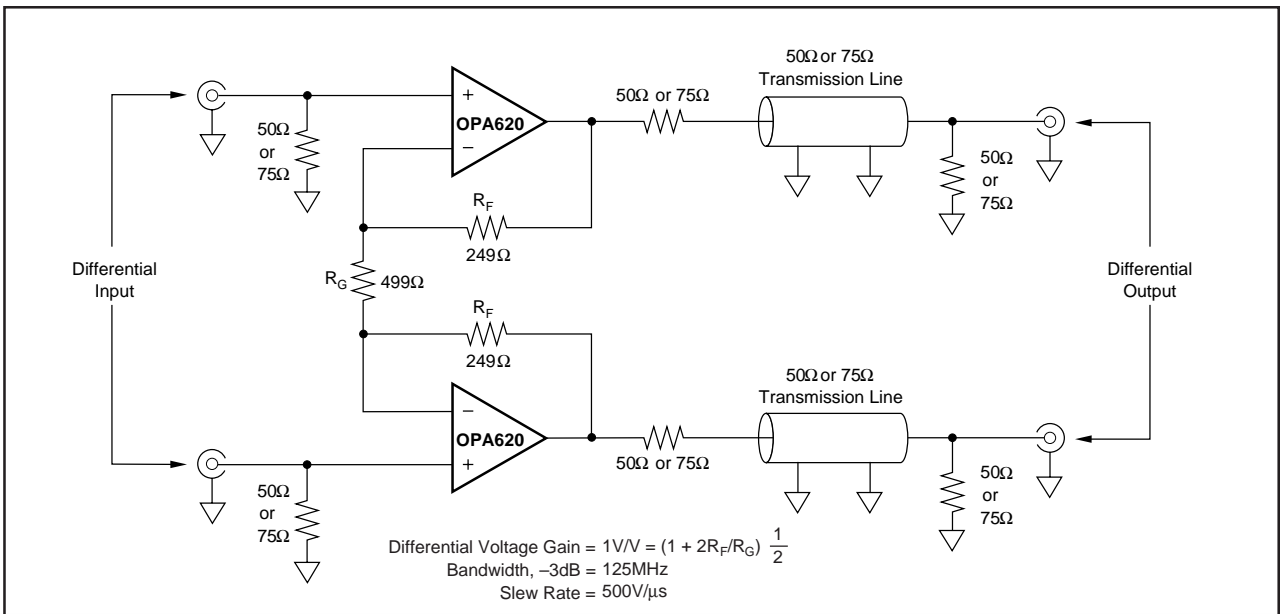


FIGURE 14. Differential Line Driver for 50Ω or 75Ω Systems.

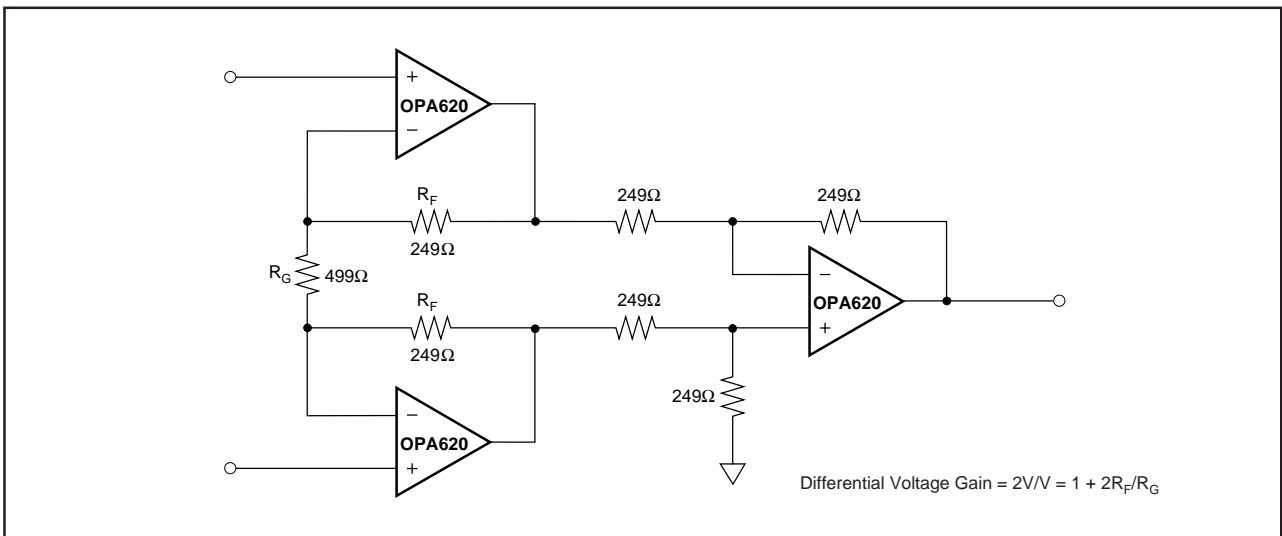


FIGURE 15. Wideband, Fast-Settling Instrumentation Amplifier.

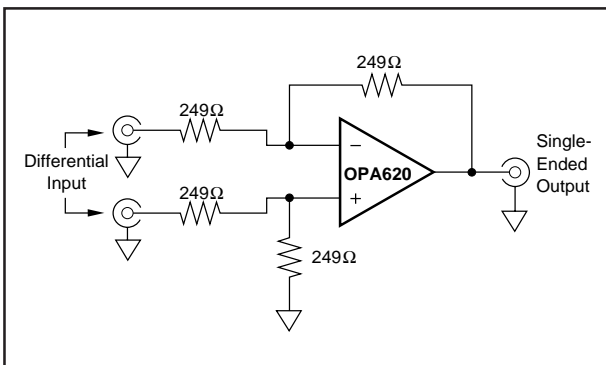


FIGURE 16. Unity Gain Difference Amplifier.

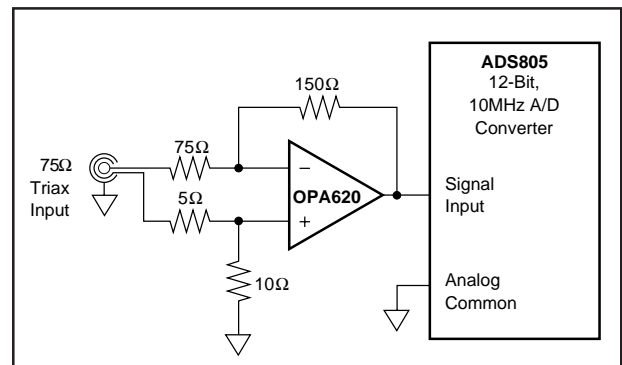


FIGURE 17. Differential Input Buffer Amplifier ( $G = -2V/V$ ).

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
OPA620KP	OBSOLETE	PDIP	P	8		TBD	Call TI	Call TI
OPA620KU	OBSOLETE	SOIC	D	8		TBD	Call TI	Call TI
OPA620KU/2K5	OBSOLETE	SOIC	D	8		TBD	Call TI	Call TI

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

<b>Products</b>		<b>Applications</b>	
Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>	Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>	Automotive	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>	Broadband	<a href="http://www.ti.com/broadband">www.ti.com/broadband</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>	Digital Control	<a href="http://www.ti.com/digitalcontrol">www.ti.com/digitalcontrol</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>	Military	<a href="http://www.ti.com/military">www.ti.com/military</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>	Optical Networking	<a href="http://www.ti.com/opticalnetwork">www.ti.com/opticalnetwork</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>	Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
		Telephony	<a href="http://www.ti.com/telephony">www.ti.com/telephony</a>
		Video & Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>
		Wireless	<a href="http://www.ti.com/wireless">www.ti.com/wireless</a>

Mailing Address: Texas Instruments  
Post Office Box 655303 Dallas, Texas 75265